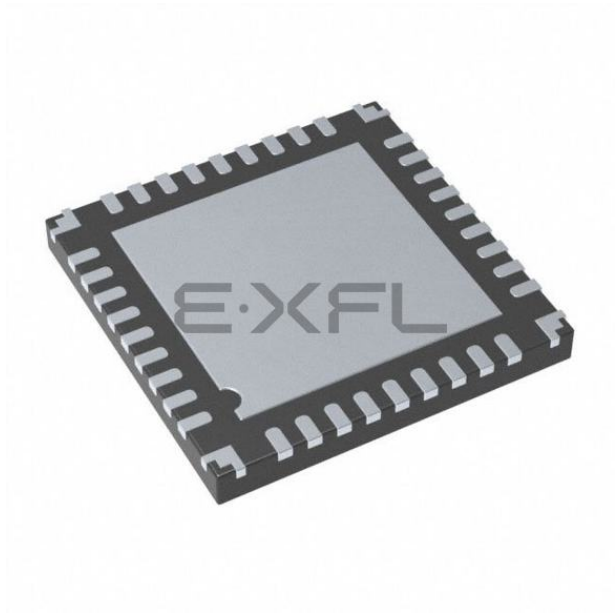
Microchip Technology - DSPIC33EV64GM103-I/M5 Datasheet



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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	dsPIC
Core Size	16-Bit
Speed	70 MIPs
Connectivity	CANbus, I²C, IrDA, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, DMA, Motor Control PWM, POR, PWM, WDT
Number of I/O	25
Program Memory Size	64KB (22K x 24)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	8K x 8
Voltage - Supply (Vcc/Vdd)	4.5V ~ 5.5V
Data Converters	A/D 13x10b/12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	36-UFQFN Exposed Pad
Supplier Device Package	36-UQFN (5x5)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/dspic33ev64gm103-i-m5

Referenced Sources

This device data sheet is based on the following individual chapters of the *"dsPIC33/PIC24 Family Reference Manual"*, which are available from the Microchip web site (www.microchip.com). The following documents should be considered as the general reference for the operation of a particular module or device feature:

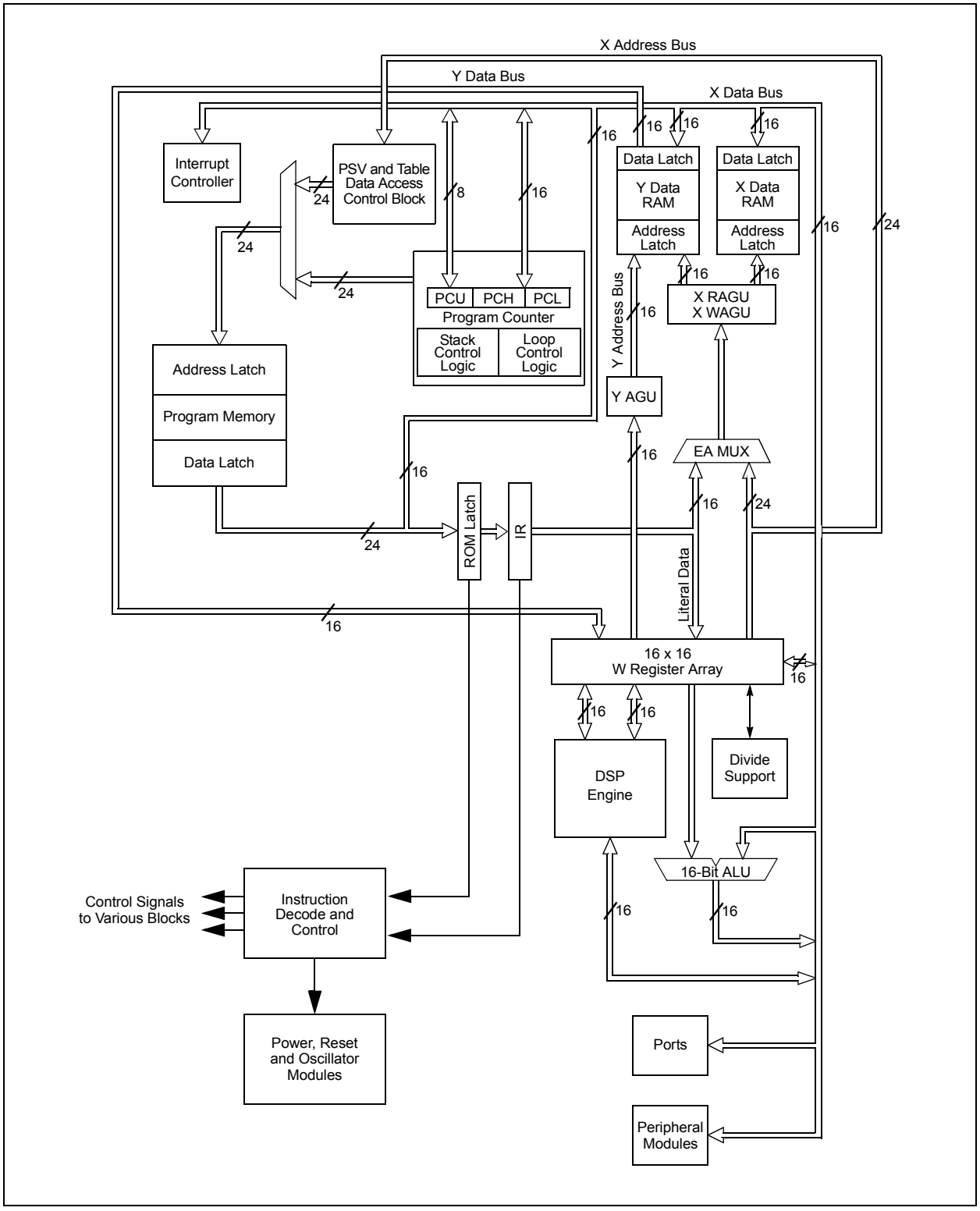
- **"Introduction"** (DS70573)
- **"CPU"** (DS70359)
- **"Data Memory"** (DS70595)
- **"dsPIC33E/PIC24E Program Memory"** (DS70000613)
- **"Flash Programming"** (DS70609)
- **"Interrupts"** (DS70000600)
- **"Oscillator"** (DS70580)
- **"Reset"** (DS70602)
- **"Watchdog Timer and Power-Saving Modes"** (DS70615)
- **"I/O Ports"** (DS70000598)
- **"Timers"** (DS70362)
- **"CodeGuard™ Intermediate Security"** (DS70005182)
- **"Deadman Timer (DMT)"** (DS70005155)
- **"Input Capture"** (DS70000352)
- **"Output Compare"** (DS70005157)
- **"High-Speed PWM"**(DS70645)
- **"Analog-to-Digital Converter (ADC)"** (DS70621)
- **"Universal Asynchronous Receiver Transmitter (UART)"** (DS70000582)
- **"Serial Peripheral Interface (SPI)"** (DS70005185)
- **"Inter-Integrated Circuit™ (I^2C™)"** (DS70000195)
- **"Enhanced Controller Area Network (ECAN™)"**(DS70353)
- **"Direct Memory Access (DMA)"** (DS70348)
- **"Programming and Diagnostics"** (DS70608)
- **"Op Amp/Comparator"** (DS70000357)
- **"Device Configuration"** (DS70000618)
- **"Charge Time Measurement Unit (CTMU)"** (DS70661)
- **"Single-Edge Nibble Transmission (SENT) Module"** (DS70005145)

TABLE 1-1: PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Type	Buffer Type	PPS	Description
SCK2	I/O	ST	Yes	Synchronous serial clock input/output for SPI2.
SDI2	I	ST	Yes	SPI2 data in.
SDO2	O	—	Yes	SPI2 data out.
SS2	I/O	ST	Yes	SPI2 slave synchronization or frame pulse I/O.
SCL1	I/O	ST	No	Synchronous serial clock input/output for I2C1.
SDA1	I/O	ST	No	Synchronous serial data input/output for I2C1.
ASCL1	I/O	ST	No	Alternate synchronous serial clock input/output for I2C1.
ASDA1	I/O	ST	No	Alternate synchronous serial data input/output for I2C1.
C1RX	I	ST	Yes	CAN1 bus receive pin.
C1TX	O	—	Yes	CAN1 bus transmit pin.
SENT1TX	O	—	Yes	SENT1 transmit pin.
SENT1RX	I	—	Yes	SENT1 receive pin.
SENT2TX	O	—	Yes	SENT2 transmit pin.
SENT2RX	I	—	Yes	SENT2 receive pin.
CVREF	O	Analog	No	Comparator Voltage Reference output.
C1IN1+, C1IN2-, C1IN1-, C1IN3-	I	Analog	No	Comparator 1 inputs.
C1OUT	O	—	Yes	Comparator 1 output.
C2IN1+, C2IN2-, C2IN1-, C2IN3-	I	Analog	No	Comparator 2 inputs.
C2OUT	O	—	Yes	Comparator 2 output.
C3IN1+, C3IN2-, C2IN1-, C3IN3-	I	Analog	No	Comparator 3 inputs.
C3OUT	O	—	Yes	Comparator 3 output.
C4IN1+, C4IN2-, C4IN1-, C4IN3-	I	Analog	No	Comparator 4 inputs.
C4OUT	O	—	Yes	Comparator 4 output.
C5IN1+, C5IN2-, C5IN1-, C5IN3-	I	Analog	No	Comparator 5 inputs.
C5OUT	O	—	Yes	Comparator 5 output.
FLT1-FLT2	I	ST	Yes	PWM Fault Inputs 1 and 2.
FLT3-FLT8	I	ST	NO	PWM Fault Inputs 3 to 8.
FLT32	I	ST	NO	PWM Fault Input 32.
DTCMP1-DTCMP3	I	ST	Yes	PWM Dead-Time Compensation Inputs 1 to 3.
PWM1L-PWM3L	O	—	No	PWM Low Outputs 1 to 3.
PWM1H-PWM3H	O	—	No	PWM High Outputs 1 to 3.
SYNCI1	I	ST	Yes	PWM Synchronization Input 1.
SYNCO1	O	—	Yes	PWM Synchronization Output 1.
PGED1	I/O	ST	No	Data I/O pin for Programming/Debugging Communication Channel 1.
PGEC1	I	ST	No	Clock input pin for Programming/Debugging Communication Channel 1.
PGED2	I/O	ST	No	Data I/O pin for Programming/Debugging Communication Channel 2.
PGEC2	I	ST	No	Clock input pin for Programming/Debugging Communication Channel 2.
PGED3	I/O	ST	No	Data I/O pin for Programming/Debugging Communication Channel 3.
PGEC3	I	ST	No	Clock input pin for Programming/Debugging Communication Channel 3.
MCLR	I/P	ST	No	Master Clear (Reset) input. This pin is an active-low Reset to the device.

Legend: CMOS = CMOS compatible input or output; Analog = Analog input; P = Power
ST = Schmitt Trigger input with CMOS levels; O = Output; I = Input
PPS = Peripheral Pin Select; TTL = TTL input buffer

FIGURE 3-1: dsPIC33EVXXXGM00X/10X FAMILY CPU BLOCK DIAGRAM



6.0 RESETS

Note 1: This data sheet summarizes the features of the dsPIC33EVXXXGM00X/10X family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to **"Reset"** (DS70602) in the *"dsPIC33/PIC24 Family Reference Manual"*, which is available from the Microchip web site (www.microchip.com).

2: Some registers and associated bits described in this section may not be available on all devices. Refer to **Section 4.0 "Memory Organization"** in this data sheet for device-specific register and bit information.

The Reset module combines all Reset sources and controls the device Master Reset Signal, $\overline{\text{SYSRST}}$. The following is a list of device Reset sources:

- POR: Power-on Reset
- BOR: Brown-out Reset
- $\overline{\text{MCLR}}$: Master Clear Pin Reset
- SWR: RESET Instruction
- WDTO: Watchdog Timer Time-out Reset
- CM: Configuration Mismatch Reset
- TRAPR: Trap Conflict Reset
- IOPUWR: Illegal Condition Device Reset
  - Illegal Opcode Reset
  - Uninitialized W Register Reset
  - Security Reset
  - Illegal Address Mode Reset

A simplified block diagram of the Reset module is shown in Figure 6-1.

Any active source of Reset will make the $\overline{\text{SYSRST}}$ signal active. On system Reset, some of the registers associated with the CPU and peripherals are forced to a known Reset state and some are unaffected.

Note: Refer to the specific peripheral section or **Section 4.0 "Memory Organization"** of this device data sheet for register Reset states.

All types of device Reset set a corresponding status bit in the RCON register to indicate the type of Reset (see Register 6-1).

A POR clears all the bits, except for the POR and BOR bits (RCON<1:0>) that are set. The user application can set or clear any bit at any time during code execution. The RCON bits only serve as status bits. Setting a particular Reset status bit in software does not cause a device Reset to occur.

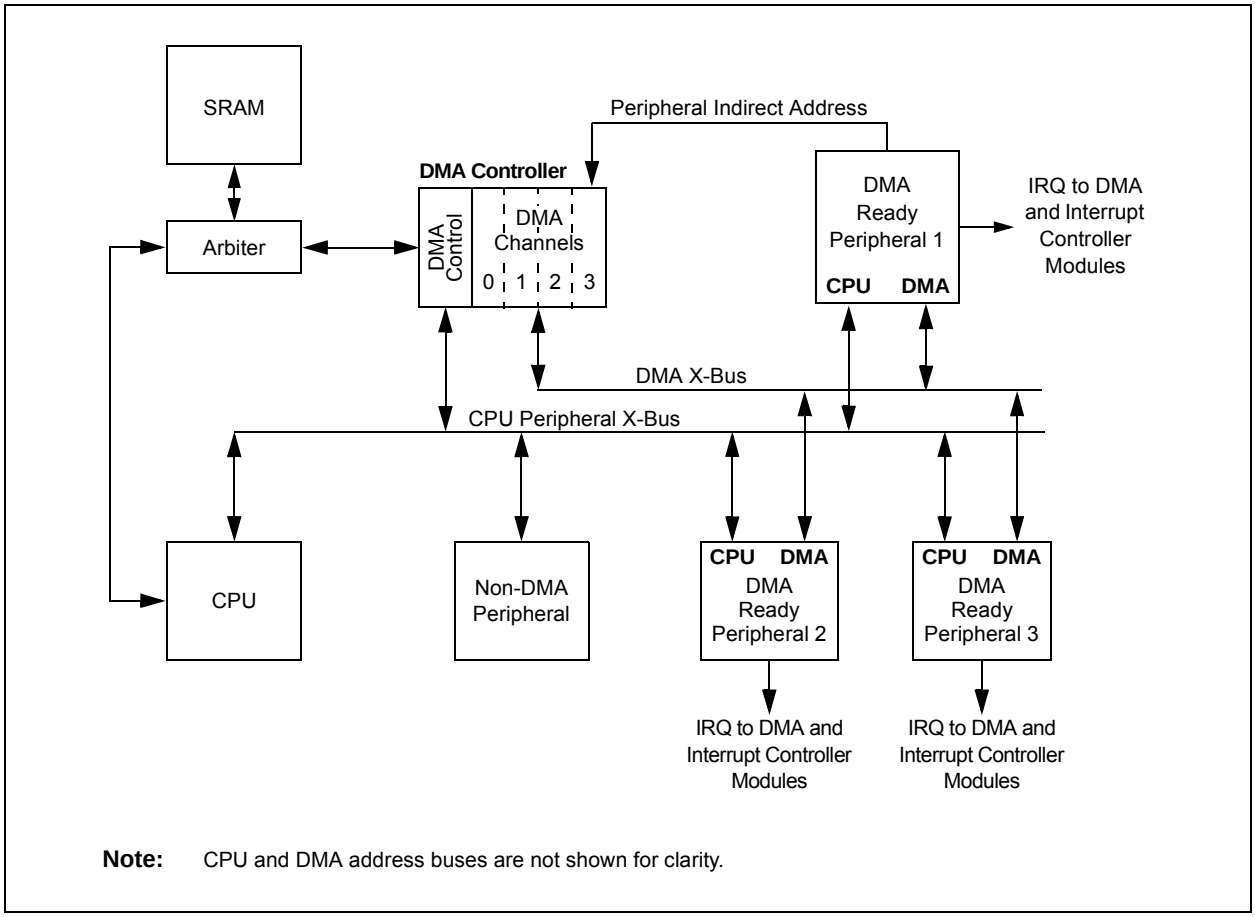
The RCON register also has other bits associated with the Watchdog Timer and device power-saving states. The function of these bits is discussed in the other sections of this device data sheet.

Note: The status bits in the RCON register should be cleared after they are read. Therefore, the next RCON register value after a device Reset is meaningful.

Note: In all types of Resets, to select the device clock source, the contents of OSCCON are initialized from the FNOSCx Configuration bits in the FOSCSEL Configuration register.

Figure 8-2 illustrates the DMA Controller block diagram.

FIGURE 8-2: DMA CONTROLLER BLOCK DIAGRAM



Note: CPU and DMA address buses are not shown for clarity.

8.1 DMAC Controller Registers

Each DMAC Channel x (where x = 0 to 3) contains the following registers:

- 16-Bit DMA Channel x Control Register (DMAxCON)
- 16-Bit DMA Channel x IRQ Select Register (DMAxREQ)
- 32-Bit DMA Channel x Start Address Register A High/Low (DMAxSTAH/L)
- 32-Bit DMA Channel x Start Address Register B High/Low (DMAxSTBH/L)
- 16-Bit DMA Channel x Peripheral Address Register (DMAxPAD)
- 14-Bit DMA Channel x Transfer Count Register (DMAxCNT)

Additional status registers (DMAPWC, DMARQC, DMAPPS, DMALCA and DSADRH/L) are common to all DMAC channels. These status registers provide information on write and request collisions, as well as on last address and channel access information.

The DMA Interrupt Flags (DMAxIF) are located in an IFSx register in the interrupt controller. The corresponding DMA Interrupt Enable bits (DMAxIE) are located in an IECx register in the interrupt controller and the corresponding DMA Interrupt Priority bits (DMAxIP) are located in an IPCx register in the interrupt controller.

REGISTER 10-5: PMD6: PERIPHERAL MODULE DISABLE CONTROL REGISTER 6

U-0	U-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0
—	—	—	—	—	PWM3MD	PWM2MD	PWM1MD
bit 15							bit 8

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 15-11 **Unimplemented:** Read as ‘0’

bit 10-8 **PWM3MD:PWM1MD:** PWMx (x = 1-3) Module Disable bit
1 = PWMx module is disabled
0 = PWMx module is enabled

bit 7-0 **Unimplemented:** Read as ‘0’

11.5.5.1 Mapping Limitations

The control schema of the peripheral select pins is not limited to a small range of fixed peripheral configurations. There are no mutual or hardware-enforced lockouts between any of the peripheral mapping SFRs. Literally any combination of peripheral mappings across any or all of the RPn pins is possible. This includes both many-to-one, and one-to-many mappings of peripheral inputs and outputs to pins. While such mappings may be technically possible from a configuration point of view, they may not be supportable from an electrical point of view.

TABLE 11-3: OUTPUT SELECTION FOR REMAPPABLE PINS (RPn)

Function	RPnR<5:0>	Output Name
Default Port	000000	RPn tied to Default Pin
U1TX	000001	RPn tied to UART1 Transmit
U2TX	000011	RPn tied to UART2 Transmit
SDO2	001000	RPn tied to SPI2 Data Output
SCK2	001001	RPn tied to SPI2 Clock Output
$\overline{SS2}$	001010	RPn tied to SPI2 Slave Select
C1TX	001110	RPn tied to CAN1 Transmit
OC1	010000	RPn tied to Output Compare 1 Output
OC2	010001	RPn tied to Output Compare 2 Output
OC3	010010	RPn tied to Output Compare 3 Output
OC4	010011	RPn tied to Output Compare 4 Output
C1OUT	011000	RPn tied to Comparator Output 1
C2OUT	011001	RPn tied to Comparator Output 2
C3OUT	011010	RPn tied to Comparator Output 3
SYNCO1	101101	RPn tied to PWM Primary Time Base Sync Output
REFCLKO	110001	RPn tied to Reference Clock Output
C4OUT	110010	RPn tied to Comparator Output 4
C5OUT	110011	RPn tied to Comparator Output 5
SENT1	111001	RPn tied to SENT Out 1
SENT2	111010	RPn tied to SENT Out 2

21.0 UNIVERSAL ASYNCHRONOUS RECEIVER TRANSMITTER (UART)

Note 1: This data sheet summarizes the features of the dsPIC33EVXXXGM00X/10X family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to **"Universal Asynchronous Receiver Transmitter (UART)"** (DS70000582) in the *"dsPIC33/PIC24 Family Reference Manual"*, which is available from the Microchip web site (www.microchip.com).

2: Some registers and associated bits described in this section may not be available on all devices. Refer to **Section 4.0 "Memory Organization"** in this data sheet for device-specific register and bit information.

The dsPIC33EVXXXGM00X/10X family of devices contains two UART modules.

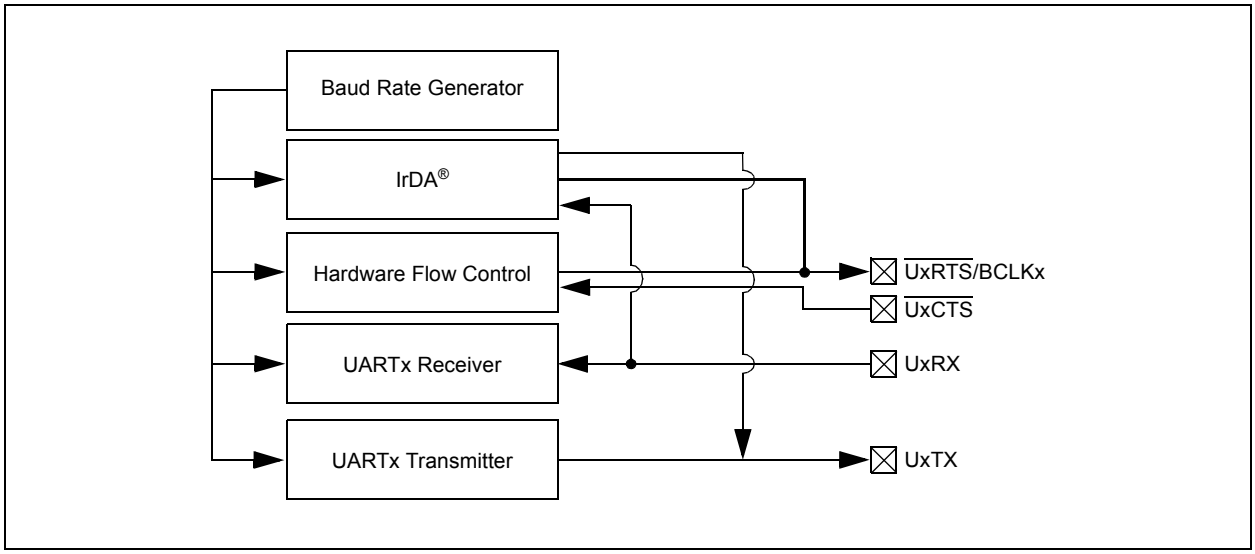
The Universal Asynchronous Receiver Transmitter (UART) module is one of the serial I/O modules available in the dsPIC33EVXXXGM00X/10X device family. The UART is a full-duplex, asynchronous system that can communicate with peripheral devices, such as personal computers, LIN/J2602, RS-232 and RS-485 interfaces. The module also supports a hardware flow control option with the $\overline{\text{UxCTS}}$ and $\overline{\text{UxRTS}}$ pins, and also includes an IrDA® encoder and decoder.

Note: Hardware flow control using $\overline{\text{UxRTS}}$ and $\overline{\text{UxCTS}}$ is not available on all pin count devices. See the **"Pin Diagrams"** section for availability.

The primary features of the UARTx module are:

- Full-Duplex, 8 or 9-Bit Data Transmission through the UxTX and UxRX Pins
- Even, Odd or No Parity Options (for 8-bit data)
- One or Two Stop Bits
- Hardware Flow Control Option with $\overline{\text{UxCTS}}$ and $\overline{\text{UxRTS}}$ Pins
- Fully Integrated Baud Rate Generator with 16-Bit Prescaler
- Baud Rates Ranging from 4.375 Mbps to 67 bps at 16x mode at 70 MIPS
- Baud Rates Ranging from 17.5 Mbps to 267 bps at 4x mode at 70 MIPS
- 4-Deep First-In First-Out (FIFO) Transmit Data Buffer
- 4-Deep FIFO Receive Data Buffer
- Parity, Framing and Buffer Overrun Error Detection
- Support for 9-Bit mode with Address Detect (9^{th} bit = 1)
- Transmit and Receive Interrupts
- A Separate Interrupt for All UART Error Conditions

FIGURE 21-1: UARTx SIMPLIFIED BLOCK DIAGRAM



26.2 Comparator Voltage Reference Registers

REGISTER 26-1: CVR1CON: COMPARATOR VOLTAGE REFERENCE CONTROL REGISTER 1

R/W-0	R/W-0	U-0	U-0	R/W-0	R/W-0	U-0	U-0
CVREN	CVROE	—	—	CVRSS	VREFSEL	—	—
bit 15							bit 8

U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	CVR6	CVR5	CVR4	CVR3	CVR2	CVR1	CVR0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15 **CVREN:** Comparator Voltage Reference Enable bit
1 = Comparator voltage reference circuit is powered on
0 = Comparator voltage reference circuit is powered down

bit 14 **CVROE:** Comparator Voltage Reference Output Enable (CVREF1O Pin) bit
1 = Voltage level is output on the CVREF1O pin
0 = Voltage level is disconnected from the CVREF1O pin

bit 13-12 **Unimplemented:** Read as '0'

bit 11 **CVRSS:** Comparator Voltage Reference Source Selection bit
1 = Comparator reference source, CVRSRC = CVREF+ – AVSS
0 = Comparator reference source, CVRSRC = AVDD – AVSS

bit 10 **VREFSEL:** Voltage Reference Select bit
1 = CVREFIN = CVREF+
0 = CVREFIN is generated by the resistor network

bit 9-7 **Unimplemented:** Read as '0'

bit 6-0 **CVR<6:0>:** Comparator Voltage Reference Value Selection bits
1111111 = 127/128 x VREF input voltage
•
•
•
0000000 = 0.0 volts

27.2 User OTP Memory

Locations, 800F80h-800FFEh, are a One-Time-Programmable (OTP) memory area. The user OTP words can be used for storing product information, such as serial numbers, system manufacturing dates, manufacturing lot numbers and other application-specific information.

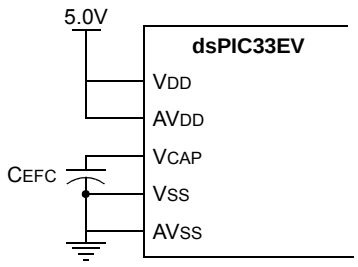
27.3 On-Chip Voltage Regulator

All of the dsPIC33EVXXXGM00X/10X family devices power their core digital logic at a nominal 1.8V. This can create a conflict for designs that are required to operate at a higher typical voltage, such as 5.0V. To simplify system design, all devices in the dsPIC33EVXXXGM00X/10X family incorporate an on-chip regulator that allows the device to run its core logic from VDD.

The regulator provides power to the core from the other VDD pins. A low-ESR (less than 1 Ohm) capacitor (such as tantalum or ceramic) must be connected to the VCAP pin (see Figure 27-1). This helps to maintain the stability of the regulator. The recommended value for the filter capacitor is provided in Table 30-5, located in **Section 30.0 "Electrical Characteristics"**.

Note:	It is important for the low-ESR capacitor to be placed as close as possible to the VCAP pin.

FIGURE 27-1: CONNECTIONS FOR THE ON-CHIP VOLTAGE REGULATOR(1,2,3)



Note 1: These are typical operating voltages. Refer to Table 30-4 located in **Section 30.1 "DC Characteristics"** for the full operating ranges of VDD and VCAP.

2: It is important for the low-ESR capacitor to be placed as close as possible to the VCAP pin.

3: Typical VCAP pin voltage = 1.8V when VDD ≥ VDDMIN.

27.4 Brown-out Reset (BOR)

The Brown-out Reset (BOR) module is based on an internal voltage reference circuit that monitors the regulated supply voltage, VCAP. The main purpose of the BOR module is to generate a device Reset when a brown-out condition occurs. Brown-out conditions are generally caused by glitches on the AC mains (for example, missing portions of the AC cycle waveform due to bad power transmission lines or voltage sags due to excessive current draw when a large inductive load is turned on).

A BOR generates a Reset pulse, which resets the device. The BOR selects the clock source based on the device Configuration bit values (FNOSC<2:0> and POSCMD<1:0>).

If an oscillator mode is selected, the BOR activates the Oscillator Start-up Timer (OST). The system clock is held until OST expires. If the PLL is used, the clock is held until the LOCK bit (OSCCON<5>) is '1'.

Concurrently, the Power-up Timer (PWRT) Time-out (TPWRT) is applied before the internal Reset is released. If TPWRT = 0 and a crystal oscillator is being used, then a nominal delay of TFSCM is applied. The total delay in this case is TFSCM. Refer to Parameter SY35 in Table 30-22 of **Section 30.0 "Electrical Characteristics"** for specific TFSCM values.

The BOR status bit (RCON<1>) is set to indicate that a BOR has occurred. The BOR circuit continues to operate while in Sleep or Idle mode and resets the device should VDD fall below the BOR threshold voltage.

TABLE 30-18: PLL CLOCK TIMING SPECIFICATIONS

AC CHARACTERISTICS			Standard Operating Conditions: 4.5V to 5.5V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended				
Param No.	**Symbol**	**Characteristic**	**Min.**	**Typ.(1)**	**Max.**	**Units**	**Conditions**
OS50	FPLLI	PLL Voltage Controlled Oscillator (VCO) Input Frequency Range	0.8	—	8.0	MHz	ECPLL, XTPLL modes
OS51	FSYS	On-Chip VCO System Frequency	120	—	340	MHz	
OS52	TLOCK	PLL Start-up Time (Lock Time)	0.9	1.5	3.1	ms	
OS53	DCLK	CLKO Stability (Jitter)(2)	-3	0.5	3	%	

Note 1: Data in "Typ." column is at 5.0V, +25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

2: This jitter specification is based on clock cycle-by-clock cycle measurements. To get the effective jitter for individual time bases or communication clocks used by the application, use the following formula:

$$\text{Effective Jitter} = \frac{DCLK}{\sqrt{\frac{FOSC}{\text{Time Base or Communication Clock}}}}$$

For example, if FOSC = 120 MHz and the SPI bit rate = 10 MHz, the effective jitter is as follows:

$$\text{Effective Jitter} = \frac{DCLK}{\sqrt{\frac{120}{10}}} = \frac{DCLK}{\sqrt{12}} = \frac{DCLK}{3.464}$$

TABLE 30-19: INTERNAL FRC ACCURACY

AC CHARACTERISTICS		Standard Operating Conditions: 4.5V to 5.5V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended					
Param No.	**Characteristic**	**Min.**	**Typ.**	**Max.**	**Units**	**Conditions**	
Internal FRC Accuracy @ FRC Frequency = 7.37 MHz(1)							
F20a	FRC	-1	0.5	+1	%	-40°C ≤ TA ≤ +85°C	VDD = 4.5-5.5V
F20b	FRC	-2	1	+2	%	-40°C ≤ TA ≤ +125°C	VDD = 4.5-5.5V

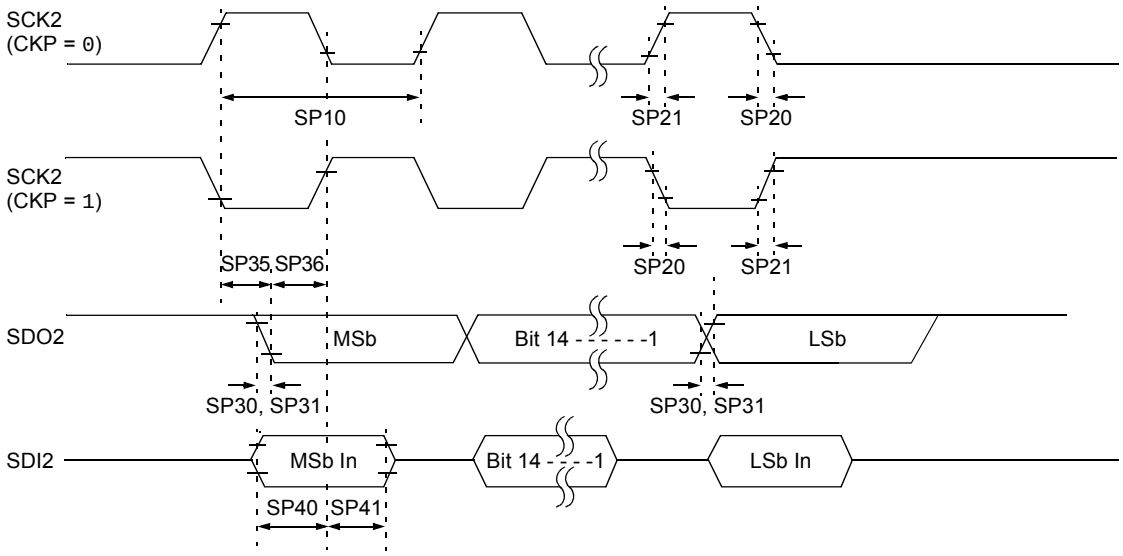
Note 1: Frequency calibrated at +25°C and 5.0V. TUN<5:0> bits can be used to compensate for temperature drift.

TABLE 30-20: INTERNAL LPRC ACCURACY

AC CHARACTERISTICS		Standard Operating Conditions: 4.5V to 5.5V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended					
Param No.	**Characteristic**	**Min.**	**Typ.**	**Max.**	**Units**	**Conditions**	
LPRC @ 32.768 kHz(1)							
F21a	LPRC	-15	5	+15	%	-40°C ≤ TA ≤ +85°C	VDD = 4.5-5.5V
F21b	LPRC	-30	10	+30	%	-40°C ≤ TA ≤ +125°C	VDD = 4.5-5.5V

Note 1: Change of LPRC frequency as VDD changes.

FIGURE 30-15: SPI2 MASTER MODE (FULL-DUPLEX, CKE = 0, CKP = x, SMP = 1) TIMING CHARACTERISTICS



Note: Refer to Figure 30-1 for load conditions.

TABLE 30-33: SPI2 MASTER MODE (FULL-DUPLEX, CKE = 0, CKP = x, SMP = 1) TIMING REQUIREMENTS

AC CHARACTERISTICS			Standard Operating Conditions: 4.5V to 5.5V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended				
Param.	**Symbol**	**Characteristic(1)**	**Min.**	**Typ.(2)**	**Max.**	**Units**	**Conditions**
SP10	FscP	Maximum SCK2 Frequency	—	—	9	MHz	-40ºC to +125ºC and see **Note 3**
SP20	TscF	SCK2 Output Fall Time	—	—	—	ns	See Parameter DO32 and **Note 4**
SP21	TscR	SCK2 Output Rise Time	—	—	—	ns	See Parameter DO31 and **Note 4**
SP30	TdoF	SDO2 Data Output Fall Time	—	—	—	ns	See Parameter DO32 and **Note 4**
SP31	TdoR	SDO2 Data Output Rise Time	—	—	—	ns	See Parameter DO31 and **Note 4**
SP35	TscH2doV, TscL2doV	SDO2 Data Output Valid after SCK2 Edge	—	6	20	ns	
SP36	TdoV2scH, TdoV2scL	SDO2 Data Output Setup to First SCK2 Edge	30	—	—	ns	
SP40	TdiV2scH, TdiV2scL	Setup Time of SDI2 Data Input to SCK2 Edge	30	—	—	ns	
SP41	TscH2diL, TscL2diL	Hold Time of SDI2 Data Input to SCK2 Edge	30	—	—	ns	

Note 1: These parameters are characterized but not tested in manufacturing.

2: Data in "Typ." column is at 5.0V, +25°C unless otherwise stated.

3: The minimum clock period for SCK2 is 111 ns. The clock generated in Master mode must not violate this specification.

4: Assumes 50 pF load on all SPI2 pins.

FIGURE 30-18: SPI2 SLAVE MODE (FULL-DUPLEX, CKE = 0, CKP = 1, SMP = 0) TIMING CHARACTERISTICS

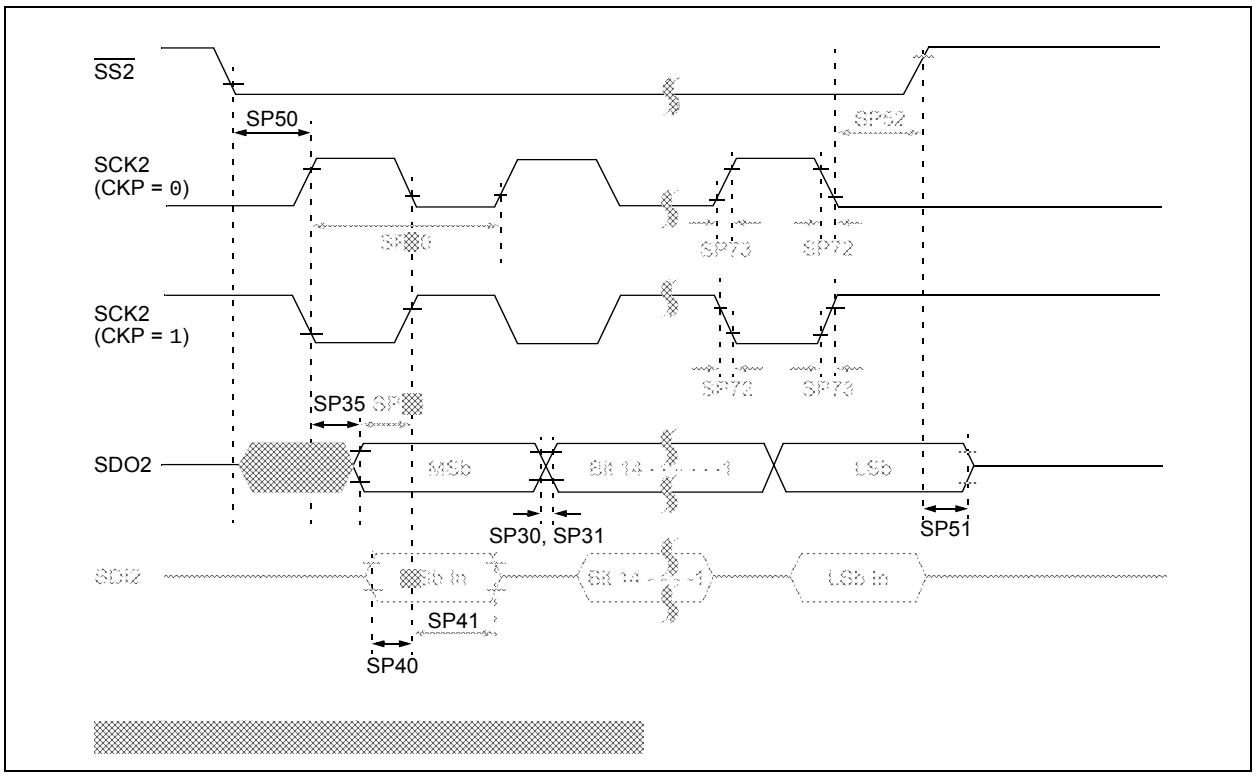


FIGURE 32-25: TYPICAL I_{IL} vs. TEMPERATURE (OSC1)

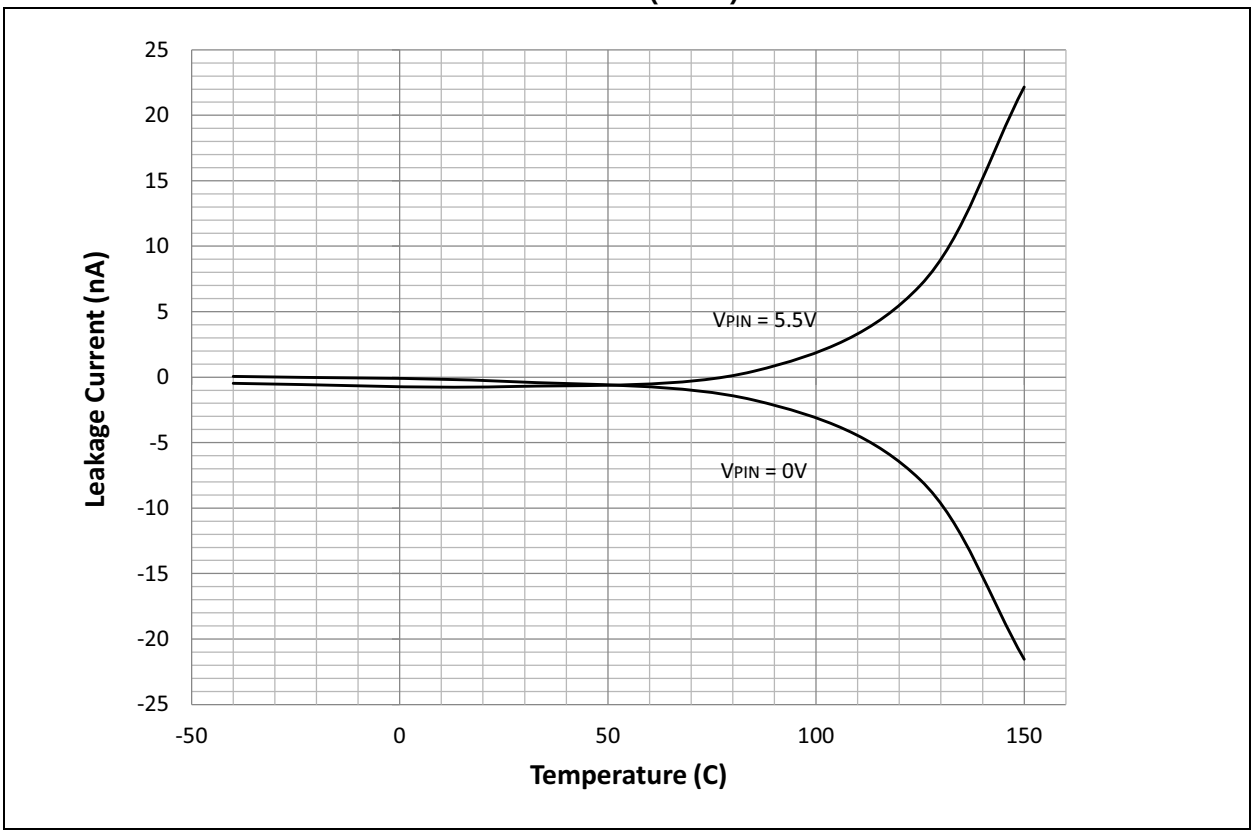


FIGURE 32-26: TYPICAL I_{IL} vs. TEMPERATURE (GENERAL PURPOSE I/Os)

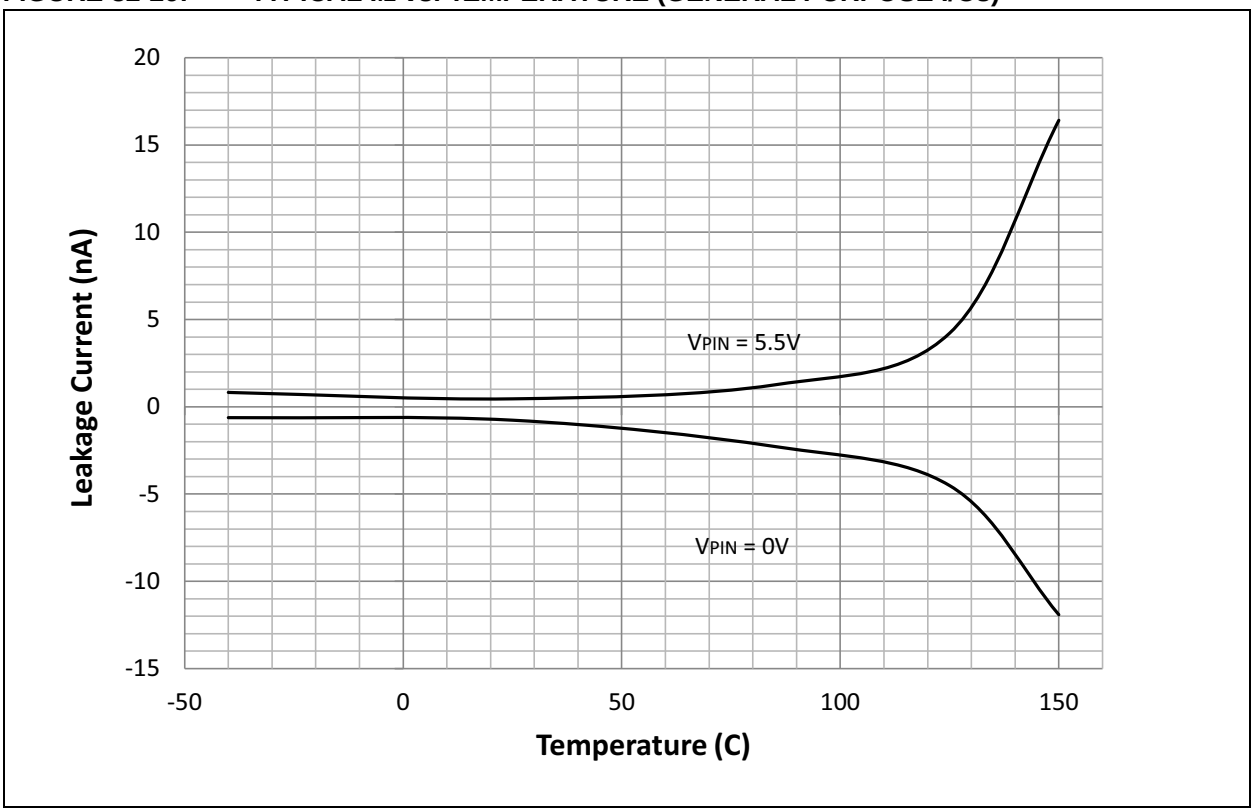
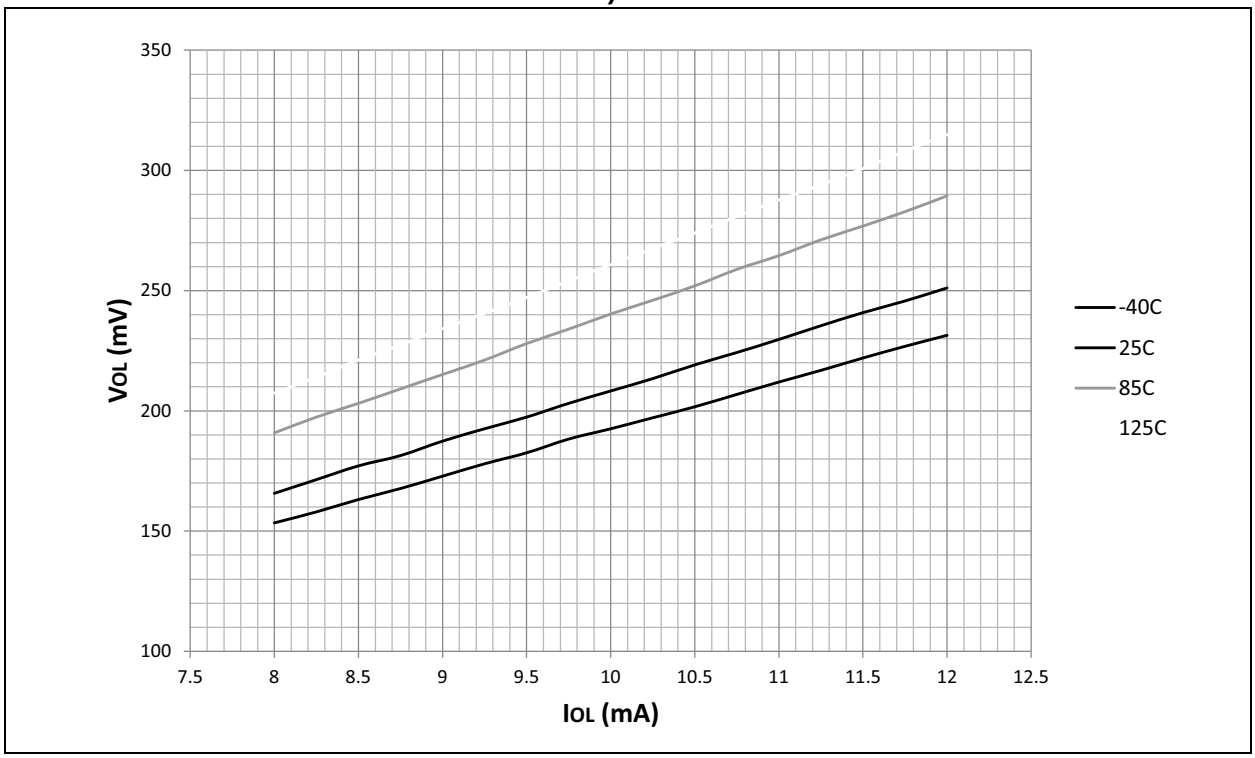
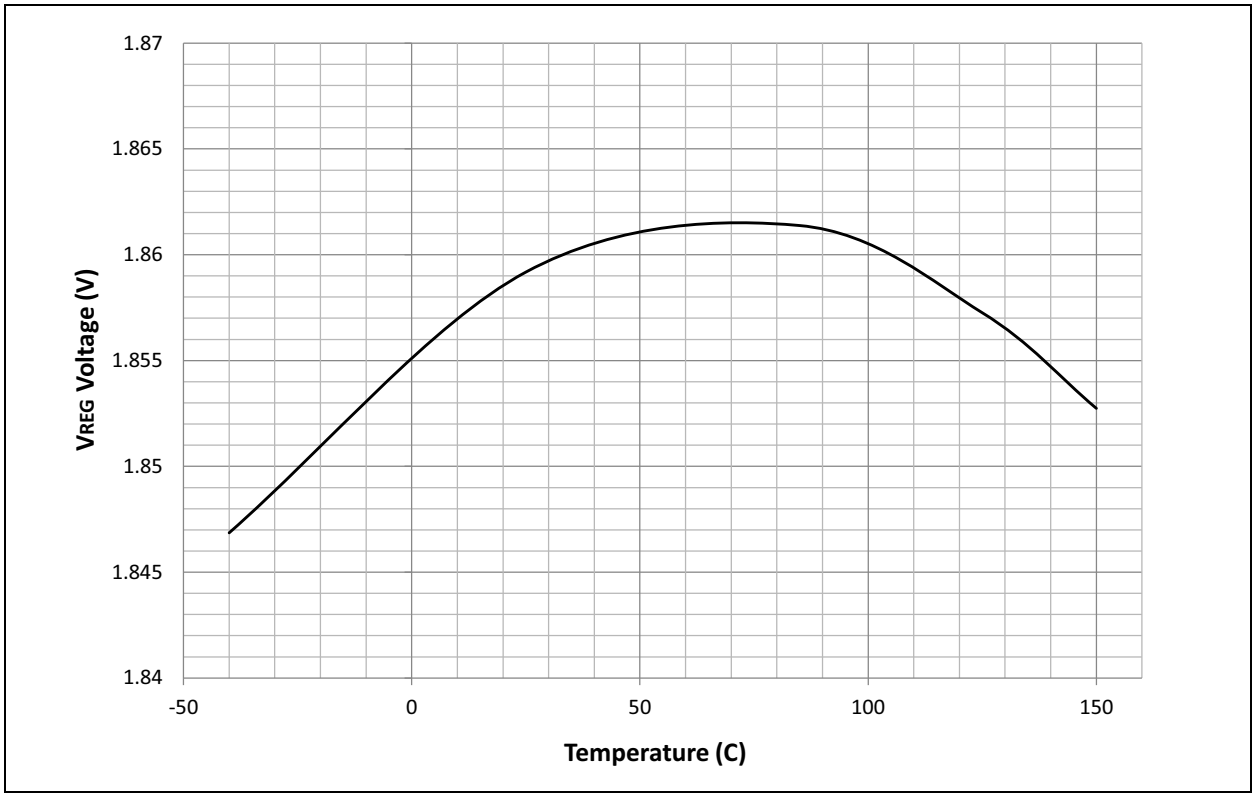


FIGURE 32-33: TYPICAL VOL 4x DRIVER PINS vs. IOL (GENERAL PURPOSE I/Os, TEMPERATURES AS NOTED)



32.11 VREG

FIGURE 32-34: TYPICAL REGULATOR VOLTAGE vs. TEMPERATURE



33.8 Pull-up/Pull-Down Current

FIGURE 33-23: TYPICAL PULL-DOWN CURRENT (V_{PIN} = 5.5V) vs. TEMPERATURE

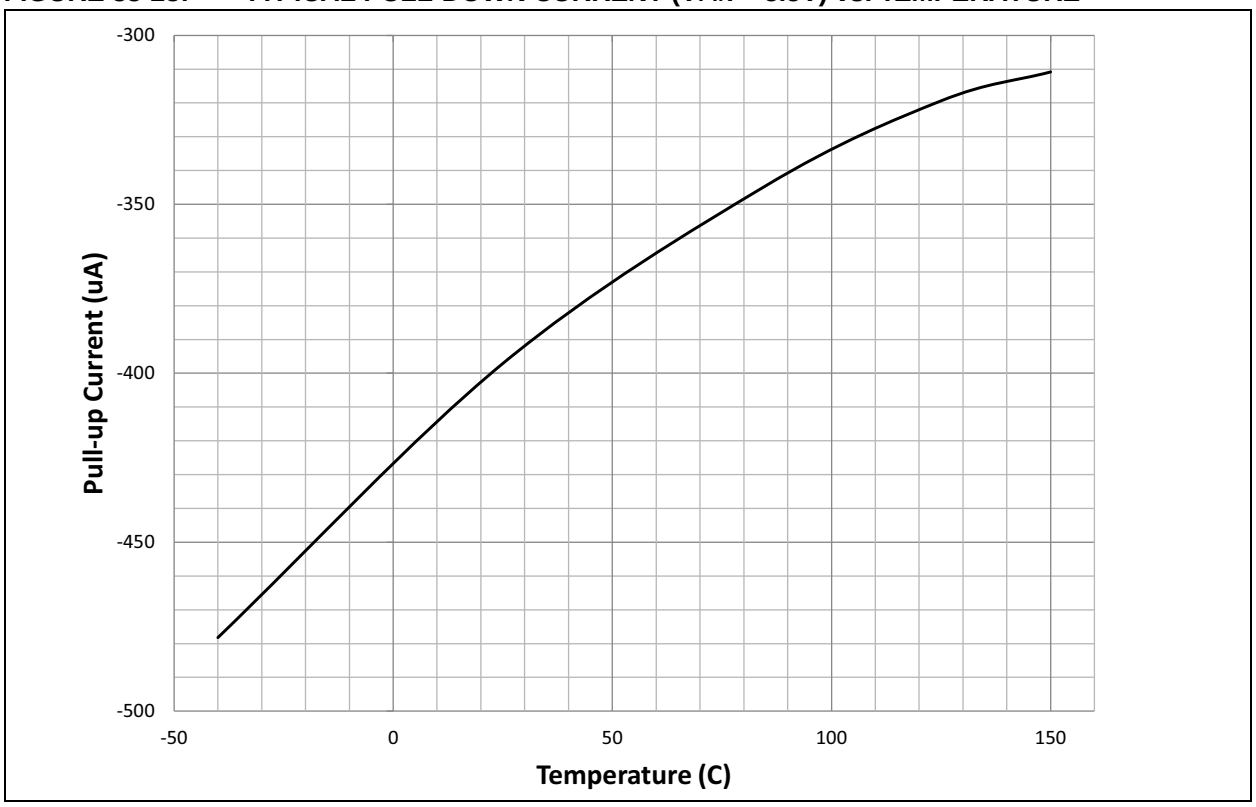
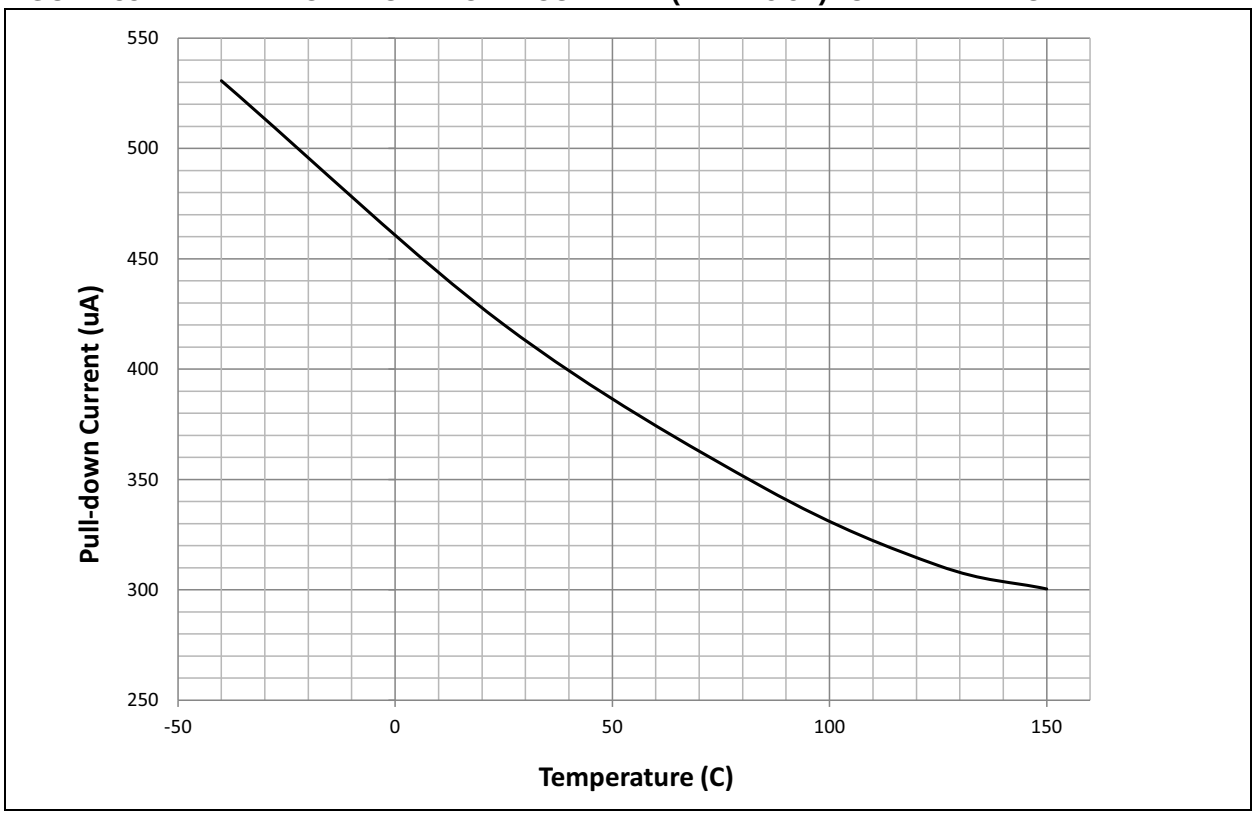


FIGURE 33-24: TYPICAL PULL-DOWN CURRENT (V_{PIN} = 5.5V) vs. TEMPERATURE



33.9 Voltage Input High (VIH) – Voltage Input Low (VIL)

FIGURE 33-25: TYPICAL VIH/VIL vs. TEMPERATURE (GENERAL PURPOSE I/Os)

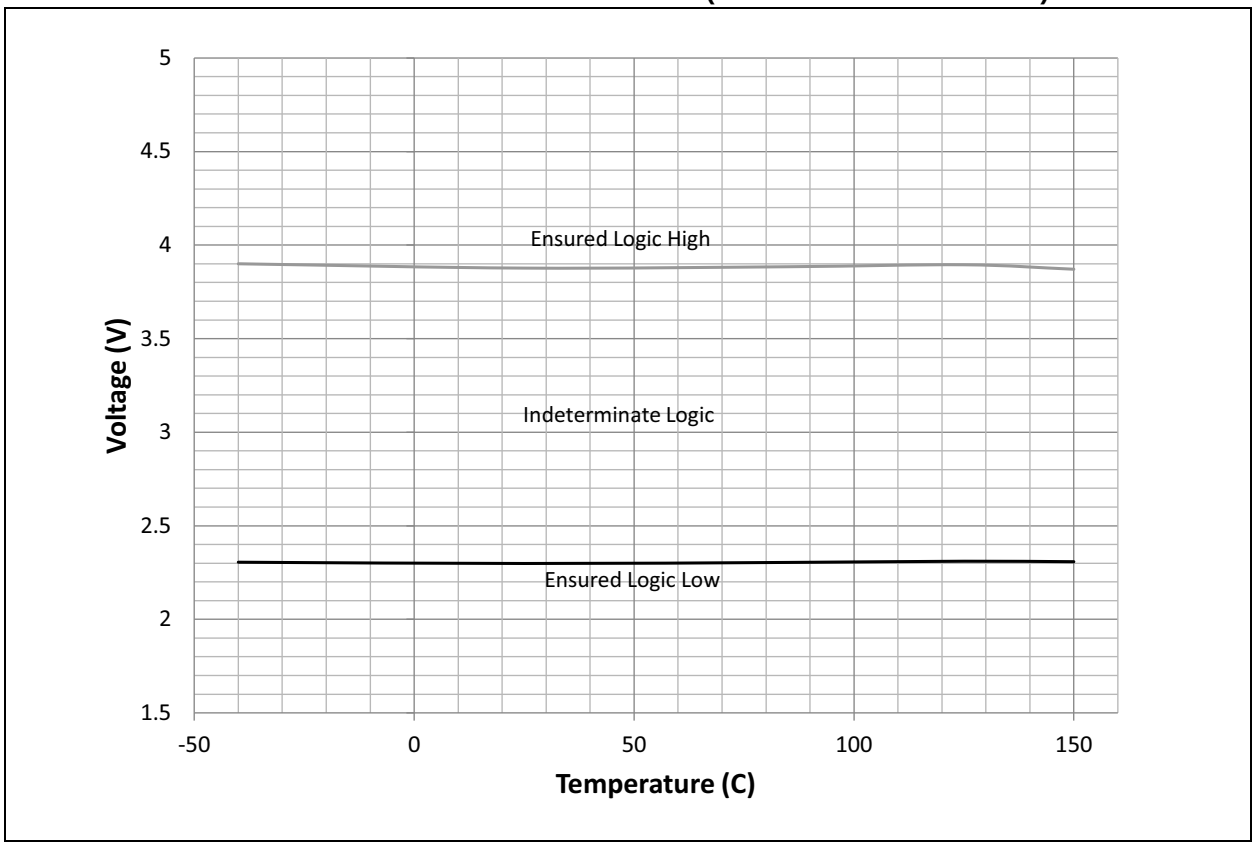


FIGURE 33-27: TYPICAL V_{OH} 4x DRIVER PINS vs. I_{OH} (GENERAL PURPOSE I/Os, TEMPERATURES AS NOTED)

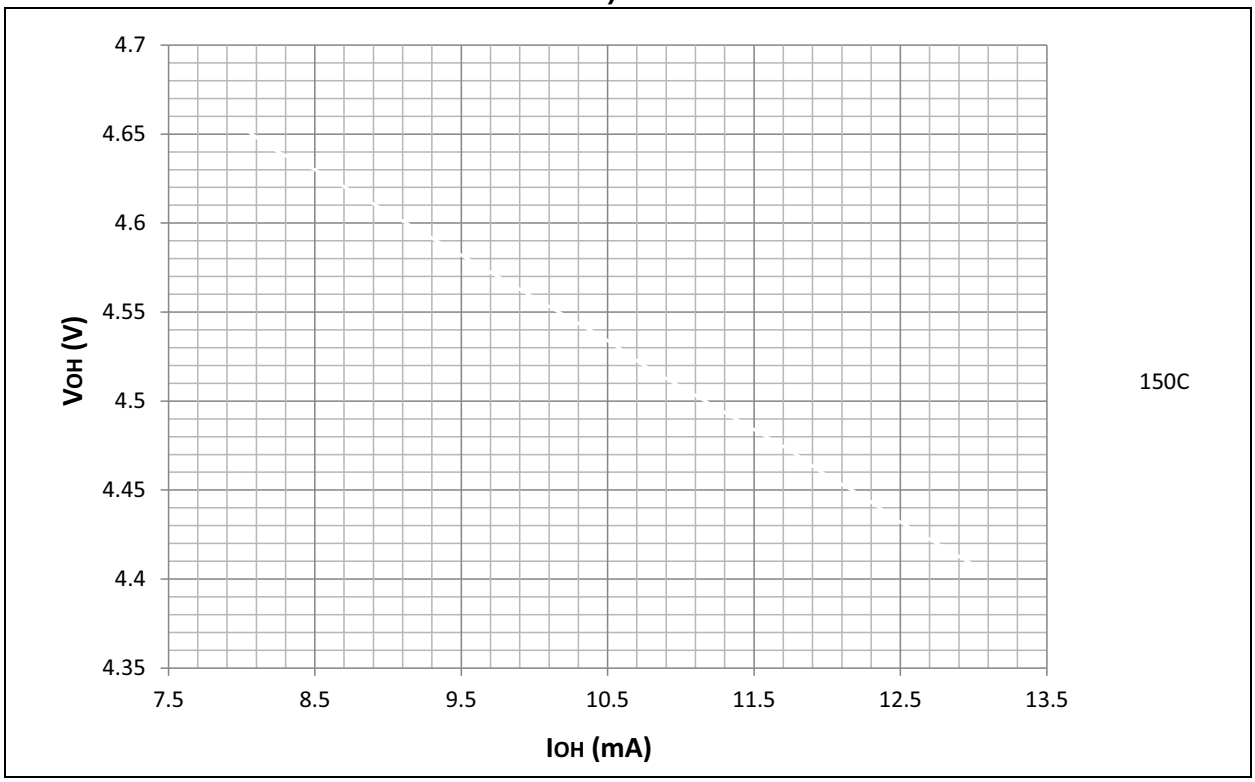
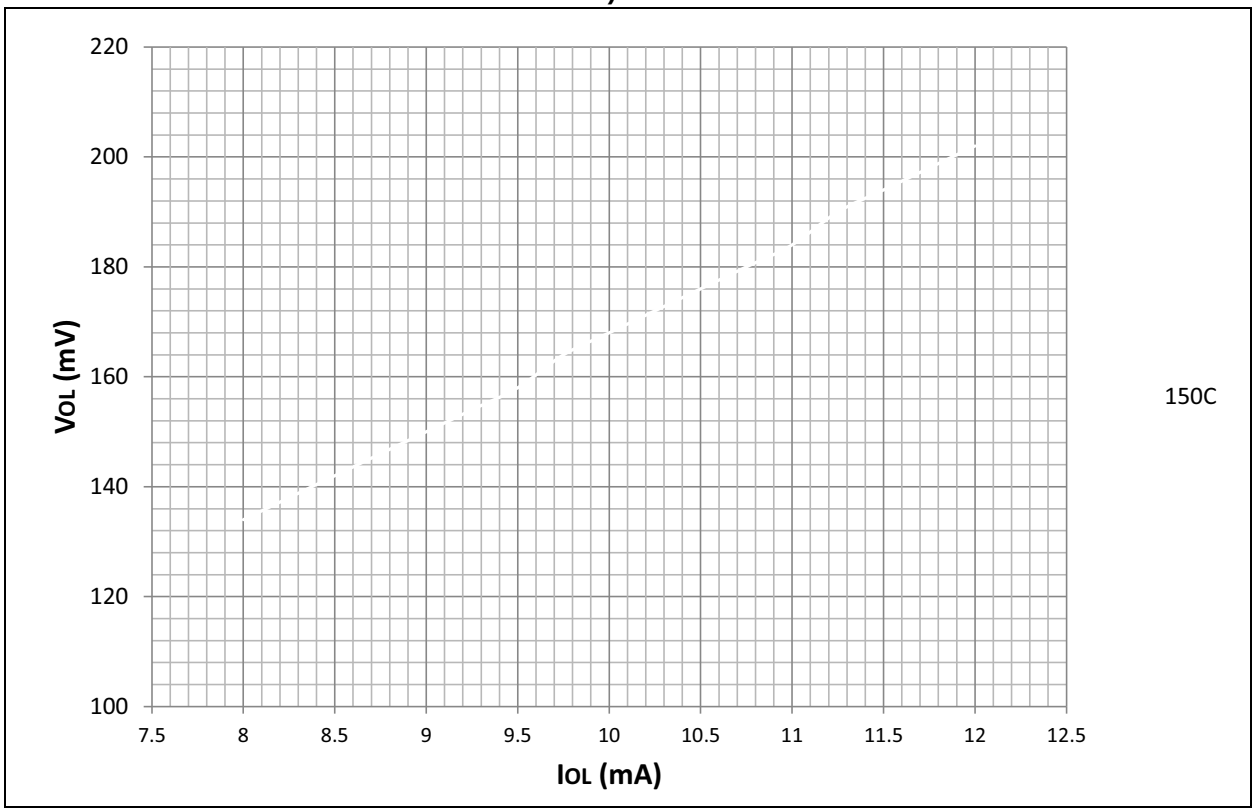


FIGURE 33-28: TYPICAL V_{OL} 8x DRIVER PINS vs. I_{OL} (GENERAL PURPOSE I/Os, TEMPERATURES AS NOTED)



INDEX

A

Absolute Maximum Ratings 341
AC Characteristics 351
  10-Bit ADC Conversion Requirements 401
  12-Bit ADC Conversion Requirements 399
  12Cx Bus Data Requirements (Master Mode) 388
  ADC Module 395
  ADC Module (10-Bit Mode) 397
  ADC Module (12-Bit Mode) 396
  CANx I/O Requirements 391
  Capacitive Loading Requirements on Output Pins 351
  DMA Module Requirements 401
  External Clock Requirements 352
  High Temperature 408
    ADC Module (10-Bit Mode) 412
    ADC Module (12-Bit Mode) 411
    Internal FRC Accuracy 409
    Internal LPRC Accuracy 409
    PLL Clock 409
  High-Speed PWMx Requirements 361
  I/O Requirements 354
  I2Cx Bus Data Requirements (Slave Mode) 390
  Input Capture x (ICx) Requirements 359
  Internal FRC Accuracy 353
  Internal LPRC Accuracy 353
  Load Conditions 351, 408
  OCx/PWMx Mode Requirements 360
  Op Amp/Comparator x Voltage Reference Settling Time 393
  Output Compare x (OCx) Requirements 360
  PLL Clock 353
  Reset, Watchdog Timer, Oscillator Start-up Timer and Power-up Timer Requirements 356
  SPI1 Master Mode (Full-Duplex, CKE = 0, CKP = x, SMP = 1) Requirements 378
  SPI1 Master Mode (Full-Duplex, CKE = 1, CKP = x, SMP = 1) 376
  SPI1 Master Mode (Half-Duplex, Transmit Only) Requirements 375
  SPI1 Slave Mode (Full-Duplex, CKE = 0, CKP = 0, SMP = 0) Requirements 386
  SPI1 Slave Mode (Full-Duplex, CKE = 0, CKP = 1, SMP = 0) Requirements 384
  SPI1 Slave Mode (Full-Duplex, CKE = 1, CKP = 0, SMP = 0) Requirements 380
  SPI1 Slave Mode (Full-Duplex, CKE = 1, CKP = 1, SMP = 0) Requirements 382
  SPI2 Master Mode (Full-Duplex, CKE = 0, CKP = x, SMP = 1) Requirements 365
  SPI2 Master Mode (Full-Duplex, CKE = 1, CKP = x, SMP = 1) Requirements 364
  SPI2 Master Mode (Half-Duplex, Transmit Only) Requirements 363
  SPI2 Slave Mode (Full-Duplex, CKE = 0, CKP = 0, SMP = 0) Requirements 373
  SPI2 Slave Mode (Full-Duplex, CKE = 0, CKP = 1, SMP = 0) Requirements 371
  SPI2 Slave Mode (Full-Duplex, CKE = 1, CKP = 0, SMP = 0) Requirements 367
  SPI2 Slave Mode (Full-Duplex, CKE = 1, CKP = 1, SMP = 0) Requirements 369
  Timer1 External Clock Requirements 357
  Timer2 and Timer4 (Type B) External Clock Requirements 358
  Timer3 and Timer5 (Type C) External Clock Requirements 358
  UARTx I/O Requirements 391
ADC
  10-Bit Configuration 285
  12-Bit Configuration 285
  Control Registers 289
  Helpful Tips 288
  Key Features 285
Alternate Interrupt Vector Table (AIVT) 95
Analog-to-Digital Converter. *See* ADC.
Assemblers
  MPASM Assembler 338
  MPLAB Assembler, Linker, Librarian 338

B

Bit-Reversed Addressing
  Example 78
  Implementation 77
  Sequence Table (16-Entry) 78
Block Diagrams
  16-Bit Timer1 Module 173
  Accessing Program Memory with Table Instructions 81
  ADCx Conversion Clock Period 287
  ADCx with Connection Options for ANx Pins and Op Amps 286
  Addressing for Table Registers 83
  Arbiter Architecture 73
  CALL Stack Frame 74
  CANx Module 254
  Comparator Voltage Reference Module 314
  Connections for On-Chip Voltage Regulator 324
  CPU Core 22
  CTMU Module 280
  Data Access from Program Space Address Generation 80
  Deadman Timer Module 181
  Digital Filter Interconnect 302
  DMA Controller 111
  dsPIC33EVXXXGM00X/10X Family 13
  EDS Read Address Generation 68
  EDS Write Address Generation 69
  High-Speed PWMx Architectural Overview 201
  High-Speed PWMx Register Interconnection 202
  I2Cx Module 230
  Input Capture x Module 189
  MCLR Pin Connections 18
  Multiplexing Remappable Output for RPn 149
  Op Amp/Comparator x Module 301
  Oscillator Circuit Placement 19
  Oscillator System 123
  Output Compare x Module 193
  Paged Data Memory Space 70
  Peripheral to DMA Controller 109
  PLL Module 124
  Recommended Minimum Connection 18
  Remappable Input for U1RX 146
  Reset System 92

SENTx Module 238
Shared I/O Port Structure 143
SPIx Module 222
Type B Timer (Timer2 and Timer4) 176
Type B/Type C Timer Pair (32-Bit Timer) 177
Type C Timer (Timer3 and Timer5) 176
UARTx Module 247
User-Programmable Blanking Function 302
Watchdog Timer (WDT) 325
Brown-out Reset (BOR) 324

C

C Compilers
MPLAB XC 338
CAN
CAN Module
Control Registers 255
Message Buffers 275
Word 0 275
Word 1 275
Word 2 276
Word 3 276
Word 4 277
Word 5 277
Word 6 278
Word 7 278
Modes of Operation 254
Overview 253
Characteristics for High-Temperature Devices (+150°C) 439
Characteristics for Industrial/Extended Temperature Devices (-40°C to +125°C) 413
Charge Time Measurement Unit (CTMU) 279
Charge Time Measurement Unit. *See* CTMU.
Code Examples
Port Write/Read 144
PORTA Slew Selections 145
PWM1 Write-Protected Register Unlock Sequence 200
PWRSAV Instruction Syntax 133
Code Protection 317, 326
CodeGuard Security 317, 326
Comparator Voltage Reference
Configuring 313
Control Registers 315
Configuration Bits 317
Description 320
Controller Area Network (CAN) 253
Controller Area Network. *See* CAN.
CPU 21
Addressing Modes 21
Arithmetic Logic Unit (ALU) 30
Control Registers 25
Data Space Addressing 21
DSP Engine 30
Instruction Set 21
Programmer's Model 23
CTMU
Control Registers 281
Customer Change Notification Service 493
Customer Notification Service 493
Customer Support 493

D

Data Address Space 36
Alignment 36
Memory Map for 256-Kbyte Devices 39
Memory Map for 32-Kbyte Devices 37
Memory Map for 64/128-Kbyte Devices 38
Near Data Space 36
SFR Space 36
Width 36
Data Space
Extended X 72
Memory Arbitration, Bus Master Priority 73
Paged Memory Scheme 68
DC Characteristics 342
Brown-out Reset (BOR) 349
CTMU Current Source 394
Doze Current (IDOZE) 347
Filter Capacitor (CEFC) Specifications 343
High Temperature 404
Brown-out Reset (BOR) 407
CTMU Current Source 410
I/O Pin Input Specifications 406
I/O Pin Output Specifications 407
Idle Current (IIDLE) 405
Op Amp/ Comparator x 411
Operating Current (IDD) 405
Operating MIPS vs. Voltage 404
Power-Down Current (IPD) 405
Program Memory 407
Temperature and Voltage Specifications 404
Doze Current (IDOZE) 405
I/O Pin Input Specifications 348
I/O Pin Output Specifications 349
Idle Current (IIDLE) 345
Internal Band Gap Reference Voltage 350
Op Amp/Comparator x Specifications 392
Op Amp/Comparator x Voltage Reference Specifications 393
Operating Current (IDD) 344
Operating MIPS vs. Voltage 342
Power-Down Current (IPD) 346
Program Memory 350
Temperature and Voltage Specifications 343
Thermal Operating Conditions 342
Deadman Timer (DMT) 181
Control Registers 182
Deadman Timer. *See* DMT.
Development Support 337
Direct Memory Access. *See* DMA.
DMA Controller
Channel to Peripheral Associations 110
Control Registers 111
Supported Peripherals 109
DMAC Registers
DMAxCNT 111
DMAxCON 111
DMAxPAD 111
DMAxREQ 111
DMAxSTAH/L 111
DMAxSTBH/L 111
DMT
Doze Mode 135